

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-160128FC-1A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS			
Product Mgr Doc. Control Electr. Eng			
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Approva	l for S	Specific	cation	only
 , .pp. 0 t a		opoomi	Julion	~,

[☐] Approval for Specification and Sample



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	10-Jul-06			First Issue	

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1 MAIN FEATURES

ITEM	CONTENTS
Display Format	160 (RGB) x 128 Dots
Overall Dimensions	Glass 35.8 x 30.8 x 1.7 mm
Colour	262,144 Colour
Active Area	28.78 x 23.024 mm
Viewing Area	30.78 x 25.02 mm
Display Mode	Passive Matrix (1.45")
Driving Method	1/128 duty
Driver IC	SEPS525F
Operating temperature	- 20 ∼ +70
Storage temperature	-30 ∼ +80

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2 MECHANICAL SPECIFICATION

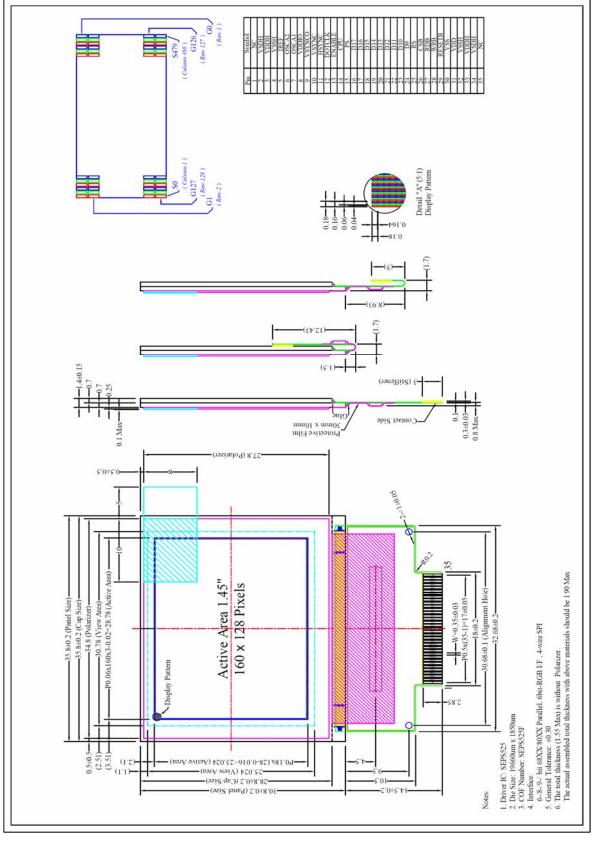
2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format	160 (RGB) x 128	Dots
Overall Dimensions	35.80 x 30.80 x 1.7	mm
Viewing Area	30.78 x 25.02	mm
Active Area	28.78 x 23.024	mm
Dot Size	0.04 x 0.164	mm
Dot Pitch	0.06 x 0.18	mm
Weight	3.6	g
IC Controller/Driver	SEPS525F (COF)	

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2.2 MECHANICAL DRAWING





3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

VSS = 0 V, Ta = 25 °C

Item	Symbol	Min	Max	Unit	Note
Power Supply Voltage	V_{DD} - V_{SS}	-0.3	4	V	
Supply Voltage for I/O Pins	V_{DDIO}	-0.3	4	V	Note 1, 2
OLED Power Supply	$V_{ m DDH}$	-0.3	19.5	V	
Operating Temperature	Тор	-30	70	°C	
Storage Temperature	Tst	-40	80	°C	
Static Electricity	Be sure that you are grounded when handling displays.				

Note 1: All the above voltages are on the basis of "GND=0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.

3.2 ELECTRICAL CHARACTERISTICS

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V_{DD}		2.6	2.8	3.3	V
Supply Voltage x I/O pins	$V_{ m DDIO}$		1.6	2.8	3.3	V
Driver Supply Voltage	V_{CC}	Note 3	-	13	-	V
High Level Input	V _{IH}		$0.8 \mathrm{xV}_\mathrm{DD}$	-	V _{DDIO}	V
Low Level Input	$V_{\rm IL}$		0	-	0.4	V
High Level Output	V_{OH}		V _{DD} -0.4	-	-	V
Low Level Output	V_{OL}		-	-	0.4	V
VDD Current	Idd	Note 1,2	-	2.5	3.5	mA
Vcc Current	Icc	Note 1	-	16	19	mA
vec Current	ICC	Note 2	-	27	32	mA

Note 1 $V_{DD} = 2.8V$, $V_{CC} = 13V$, Software initial setting follow chapter 5.4, 50% Display area turned on.

Note 2 $V_{DD} = 2.8V$, $V_{CC} = 13V$, Software initial setting follow chapter 5.4, 100% Display area turned on

Note 3 Brightness (Lbr) and driver supply voltage (VCC) could be changed to customer request.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Symbol	I/O	Function			
1	N.C.	-	No Connection			
2	VSDH	I	Data Driver Ground			
3	VDDH	I	Data, Scan Driver Power supply			
4.	VSSH	I	Scan Driver Ground			
5	IREF	I/O	Current reference for brightness Adjustment Connect 70ΚΩ Resistor to VSS			
6	OSCA2	О	Fine Adjustment for Oscillation			
7	OSCA1	I	Connect a 10KΩ Resistor between OSCA1 and OSCA2. OSCA1 is selected for External clock mode.			
8	VDDIO	I	MPU I/F PAD Power Supply			
9	VSYNCO	О	RGB Mode functional Pins			
10	VSYNC	I	NOD Mode functional I ins			
11	HSYNC	I	VSYNCO: Vertical Sync Output VSYNC: Vertical Sync Input			
12	COTCLK	I	HSYNC: Horizontal Sync Input			
13	ENABLE	I	COTCLK: Dot Clock Input ENNABLE: Video Enable Input			
14	СРИ	I	Select CPU type Low: 80-Series High: 68-Series			
15	PS	I	Select Parallel/Serial Interface Low: Serial High: Parallel			
16	D17		Host Data Input/Output Bus.			
17	D16		These pins are 9-bit bi-directional data bus to be			
18	D15		connected with MCU data bus.			
19	D14		De Description			
20	D13	I/O	PS Description			
21	D12		1 8-bit Bus: D17 to D10 9-bit Bus: D17 to D9			
22	D11		D[17] SCL: Synchronous Clock Input			
23	D10		0 D[16] SDI: Serial Data Input D[15] SDO: Serial Data Output			
24	D9		D[10] 5DO. Seriai Data Output			

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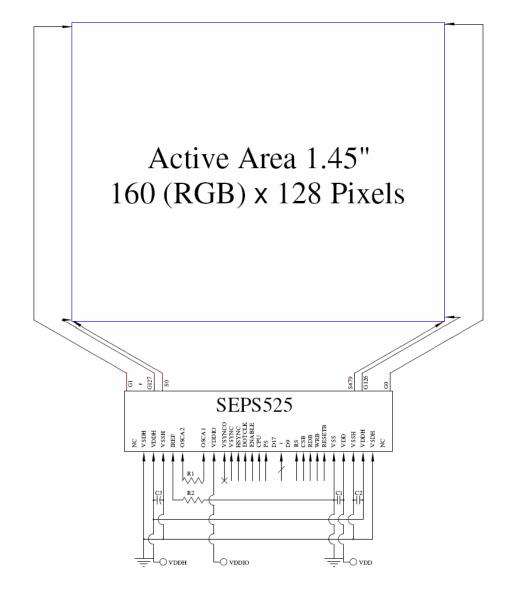
25	RS	I	Selects Data/Command Low: Command High: Parameter/data
26	CSB	I	Chip Select Low: SEPS525 is selected and can be accessed High: SEPS525 is not selected and cannot be accessed
27	RDB	I	Read/Write Select or Write. 80-System bus interface: Read strobe signal (Active Low) 68-System bus interface: Bus enable strobe (Active High) When serial mode, fix this to VDD or VSS Level
28	WRB	I	Write or Read/Write Select 80-System bus interface: Write strobe signal(active Low) 68-System bus interface: Read/write select. Low: Write High: Read When serial mode, fix this to VDD or VSS Level
29	RESETB	I	Chip Reset Reset SEPS225 (Active Low)
30	VSS	I	Power Supply Ground
31	VDD	I	Logic Power Supply
32	VSSH	I	Scan Driver Ground
33	VDDH	I	Data, Scan Driver Power supply
34	VSDH	I	Data Driver Ground
35	N.C.	-	No Connection

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3.4 BLOCK DIAGRAM



MCU Interface Selection: PS and CPU

Pins connected to MCU interface: D17~D9, RS, CSB, RDB, WRB, RESETB,

ENABLE, DOTCLK, HSYNC and VSYNC

When RGB mode is used, D[17:12], ENABLE, DOTCLK, HSYNC and VSYNC Should follow the 6-bit RGB interface instruction. Otherwise these four inputs ENABLE, DOTCLK, HSYNC and VSYNC should be tied to VDDIO Level.

 $\begin{array}{ccc} C1: & 1 \ \mu F \\ C2, C3: & 4.7 \mu F \\ R1: & 10 \ k\Omega \\ R2: & 68 \ k\Omega \end{array}$

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3.5 TIMING CHARACTERISTICS

3.5.1 AC CHARACTERISTICS

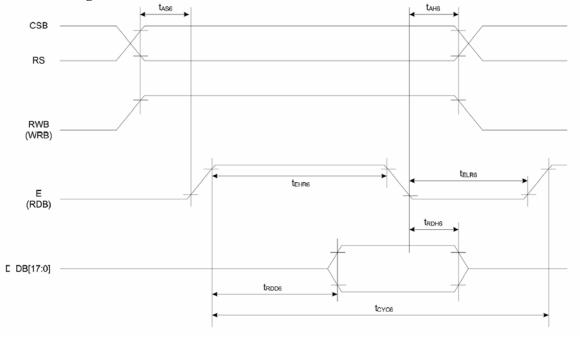
3.5.1.1 6800-Series MPU Parallel Interface Timing Characteristics

VDD = 2.8V, Ta = 25°C

VDD 2.0V, 1u 25 C						
Characteristics	Symbol	Min	Max	Unit	Unit	
Write Timing						
Address hold timing	tAH6	5	- nS		CSB	
Address setup timing	tAS6	5] -	113	RS	
System cycle timing Write	tCYC6	100				
"L" pulse width Write	tELW6	45] -]	nS	Е	
"H" pulse width	tEHW6	45				
Data setup timing	tDS6	40	-	n C	DB[17:0]	
Data hold timing	tDH6	10		nS		
Read Timing						
Address hold timing	tAH6	10		nC	CSB	
Address setup timing	tAS6	10	-	nS	RS	
System cycle timing Write	tCYC6	200				
"L" pulse width Write	tELW6	90	-	nS	Е	
"H" pulse width	tEHW6	90	1			
Data setup timing (CL= 15pF)	tDS6	0	70	nS	DR[17:0]	
Data hold timing (CL= 15pF)	tDH6	U	U	70	113	DB[17:0]
				_		

• All the timing should be based on 10% and 90% of V_{DD} .

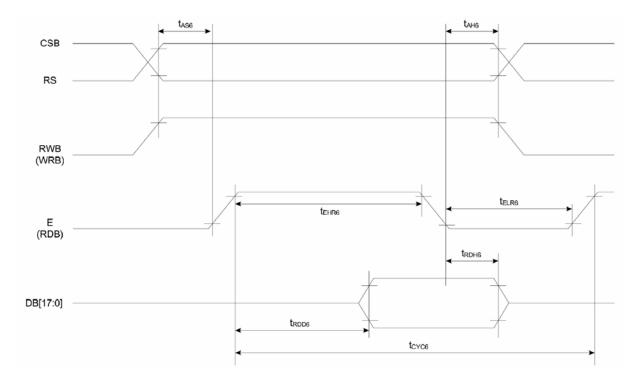
Write Timing



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Read Timing



3.5.1.2 8080-Series MPU Parallel Interface Timing Characteristics

Characteristics	Symbol	Min	Max	Unit	Unit
Write Timing					
Address hold timing	tAH6	5		nS	CSB
Address setup timing	tAS6	5	-	113	RS
System cycle timing Write	tCYC6	100			
"L" pulse width Write	tELW6	45	-	nS	WRB
"H" pulse width	tEHW6	45			
Data setup timing	tDS6	30	-	nS	DB[17:0]
Data hold timing	tDH6	10			
Read Timing					
Address hold timing	tAH6	10		n C	CSB
Address setup timing	tAS6	10] -	nS	RS
System cycle timing Write	tCYC6	200			
"L" pulse width Write	tELW6	90] -	nS	RDB
"H" pulse width	tEHW6	90			
Data setup timing (CL= 15pF)	tDS6	0	60	60 nS	DB[17:0]
Data hold timing (CL= 15pF)	tDH6	U			

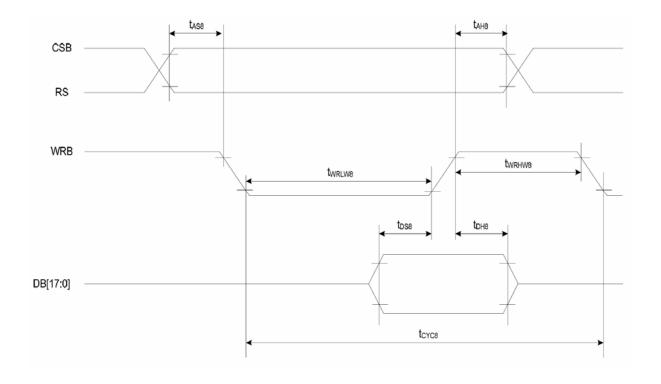
^{*} All the timing should be based on 10% and 90% of V_{DD}

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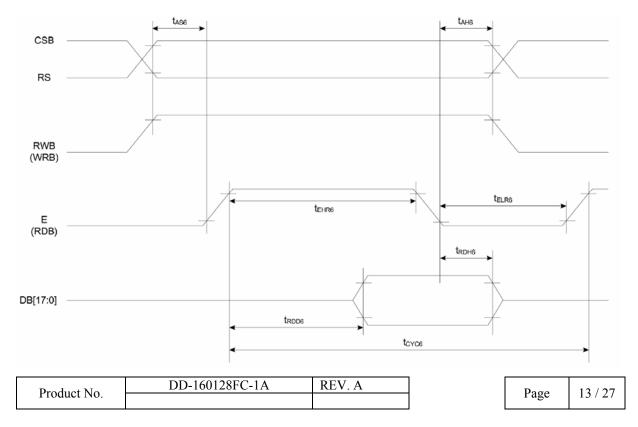
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Write Timing



Read timing



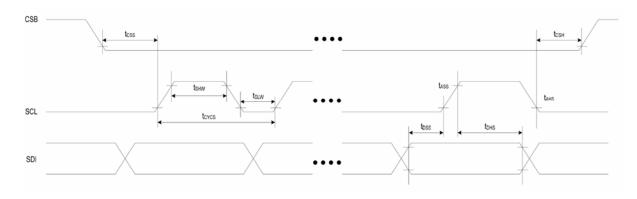


3.5.1.3 Serial Interface Timing Characteristics

ITEM	SYMBOL	MIN	MAX	UNIT	PORT
Serial clock cycle SCL	tCYCS	60		- nS	SCL
"H" pulse width SCL	tSHW	25] -		
"L" pulse width	tSLW	25			
Data setup timing Data	tDSS	25		nS	SDI
Hold timing	tDHS	25	-	113	SDI
CSB-SCL timing	tCSS	25		- nS	CSB
CSB-hold timing	tCSH	25] -		CSB

^{*} All the timing should be based on 10% and 90% of V_{DD}

Serial Interface Timing



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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness(White)	L_{br}	Display Average Note 1	75	100	-	cd/m ²
CIE (MI:	(X)		0.25	0.29	0.33	
C.I.E.(White)	(Y)		0.29	0.33	0.37	-
C.I.E.(Red)	(X)		0.57	0.61	0.65	
	(Y)		0.32	0.36	0.40	-
CIE(C)	(X)		0.26	0.30	0.34	
C.I.E.(Green)	(Y)		0.60	0.64	0.68	-
C.I.E.(Blue)	(X)		0.10	0.14	0.18	
	(Y)		0.15	0.19	0.23	-
Dark Room Contrast	CR		-	>1000:1	-	-
Viewing Angle	C 11 41	01	>160	-	-	degree

Optical measurement, follow the software initial setting on chapter 5.4

Note 1: Brightness (Lbr) and driver supply voltage (VCC) could be changed to customer request.

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5 FUNCTIONAL SPECIFICATION

5.1 COMMANDS

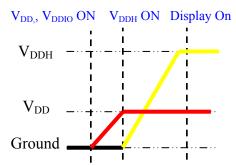
Please refer to the Technical Manual for the SEPS525F

5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

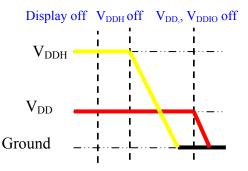
5.2.1 POWER UP SEQUENCE

- 1. Power up $V_{DD \&} V_{DD IO}$
- 2. Send Display off command
- 3. Clear Screen
- 4. Power up V_{DDH}
- 5. Delay 100ms (When V_{DD} & V_{DDIO} is stable)
- 6. Send Display on command



5.2.2 POWER DOWN SEQUENCE

- 1. Send Display off command
- 2. Power down V_{DDH}
- 3. Delay 100ms (When V_{DDH} reach 0 and panel is completely discharges)
- 4. Power down V_{DD} & V_{DDIO}



5.3 RESET CIRCUIT

When RESETB input is low, the chip is initialized with the following status:

- 1. Frame frequency: 90Hz
- 2. OSC: internal OSC
- 3. Internal OSC: ON
- 4. DDRAM write horizontal address: MX1 = 00h, MX2 = 9Fh
- 5. DDRAM write vertical address: MY1 = 00h, MY2 = 7Fh
- 6. Display data RAM write: HC = 1, VC = 1, HV = 0
- 7. RGB data swap: OFF
- 8. Row scan shift direction: G0, G1, ..., G126, G127
- 9. Column data shift direction: S0, S1, ..., S478, S479
- 10. Display ON/OFF: OFF
- 11. Panel display size: FX1 = 00h, FX2 = 9Fh, FY1 = 00h, FY2 = 7Fh
- 12. Display data RAM read column/row address: FAC = 00h, FAR = 00h
- 13. Pre-charge time(R/G/B): 0 clock
- 14. Pre-charge current(R/G/B): 0 uA
- 15. Driving current(R/G/B): 0 uA

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5.4 ACTUAL APPLICATION EXAMPLE

```
Initial Code:
   //OSC control
   //EXPORT1 internal clock and OSC operates with external resiste
      Write_Register(0x02);
      Write Parameter(0x01);
   //REDUCE CURRENT
   //Reduced driving current : normal
   //Power save mode:normal
      Write Register(0x04);
      Write_Parameter(0x00);
   //CLOCK_DIV
   //OSC frequency setting: 90Hz
   //Display frequency divide ration:1
      Write Register(0x03);
      Write_Parameter(0x30);
   //IREF→Reference volt. controlled by External resister
   //→RGB current and precharge time, current separate control
      Write_Register(0x80);
      Write_Parameter(0x00);
   //PRECHARGE TIME R
   //1 Precharge Time
      Write Register(0x08);
      Write Parameter(0x01);
   //PRECHARGE TIME G
   //1 Precharge Time
      Write Register(0x09);
      Write Parameter(0x01);
   //PRECHARGE TIME B
   //1 Precharge Time
      Write Register(0x0A);
      Write Parameter(0x01);
   //PRECHARGE_CURRENT_R
      Write Register(0x0B);
      Write Parameter(0x0A);
   //PRECHARGE_CURRENT_G
      Write Register(0x0C);
      Write Parameter(0x0A);
   //PRECHARGE_CURRENT_B
      Write Register(0x0D);
      Write_Parameter(0x0A);
   //DRIVING_CURRENT_R
   //82uA
      Write_Register(0x10);
      Write_Parameter(0x52);
```

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```
//DRIVING CURRENT G
//56uA
   Write Register(0x11);
   Write Parameter(0x38);
//DRIVING_CURRENT_B
//58uA
   Write_Register(0x12);
   Write Parameter(0x3A);
//Display mode set
//RGB,column=0→159,column data display control=Normal Dispaly
   Write Register(0x13);
   Write_Parameter(0x00);
//External interface mode =MPU
   Write Register(0x14);
   Write Parameter(0x01);
//MEMORY WRITE MODE
//6btis Triple transfer,262K support ,Horizontal address counter is increased, Vertical
 address
//counter is increased, The data is continuously written horizontally
   Write_Register(0x16);
   Write Parameter(0x76);
//Memory Address setting range 0x17~0x19 →160x128
   Write Register(0x17); //column start
   Write Parameter(0x00);
   Write Register(0x18); //column end
   Write_Parameter(0x9F);
   Write Register(0x19); //row start
   Write Parameter(0x00);
   Write Register(0x1A); //row end
   Write Parameter(0x7F);
//Memory Start Address set 0x20~0x21
   Write_Register(0x20); // X
   Write Parameter(0x00);
   Write Register(0x21); // Y
   Write Parameter(0x00);
//DUTY
   Write Register(0x28);
   Write Parameter(0x7F);//128
//Display Start Line
   Write Register(0x29);
   Write Parameter(0x00);
//DDRAM Read Address Start point 0x2E~0x2F
   Write Register(0x2E); // X
   Write_Parameter(0x00);
   Write Register(0x2F); // Y
   Write Parameter(0x00);
```

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//Display Screen Saver Size 0x33~0x36
Write_Register(0x33); //Display Screen Saver Columns Start
Write_Parameter(0x00);
Write_Register(0x34); //Display Screen Saver Columns End
Write_Parameter(0x9F);
Write_Register(0x35); //Display Screen Saver Row Start
Write_Parameter(0x00);
Write_Register(0x36); //Display Screen Saver Row End
Write_Parameter(0x7F);
Write_Register(0x06); //Display ON
Write_Parameter(0x01);

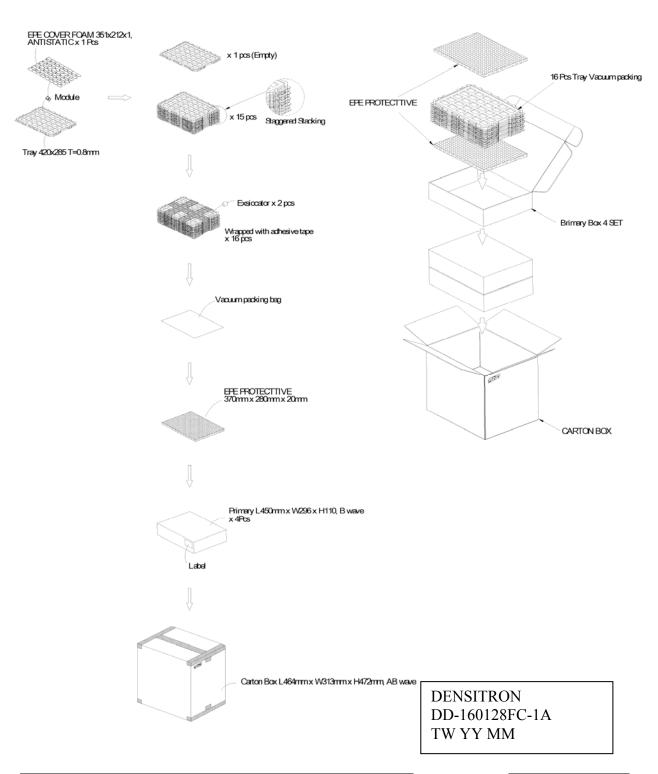
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6 PACKAGING AND LABELLING SPECIFICATION

6.1 LABELLING & MARKING



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

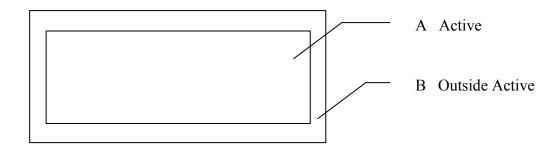
7.2.1 DELIVERY INSPECTION STANDARDS

MIL-STD-105E, general inspection level II, single sampling level; IPC-AA610 rev. C, class 2 electronic assemblies standard

The quality assurance levels are shown below:

Class	AQL (%)
Critical defect	0.5%
Major defect	1.0%
Minor defect	1.5%
TOTAL	2.0%

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions

Temperature: 23 ± 5 °C

Humidity: 55 ± 15 %RH

Fluorescent lamp: 30 WDistance between the Panel & Eyes of the Inspector: $\ge 30 \text{cm}$ Distance between the Panel & the lamp: $\ge 50 \text{cm}$

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7.2.4 Standard of appearance inspection

Units: mm

Ullits. III						
Class	Item	Criteria				
Minor	Packing &	Outside & inside package Presence of product no., lot no., quantity				
Critical	Label	Product mus	t not be mixe	d with others and	quantity must not	be different from
			d on the label			
Major	Dimension	Product dim	ensions must	be according to sp	pecification and di	rawing
Major	Electrical	Product elec	trical characte	eristics must be ac	cording to specifi	cation
Critical	OLED Display	Missing line allowed	s, short circui	its or wrong patter	ns on OLED disp	lay are not
Minor	Black spot, white spot,	Round type: $\emptyset = (X+Y)/2$	as per follow	ring drawing		
	dust			A	cceptable quantity	/
				Size	Zone A	Zone B
			<u> </u>	Ø<0.1	Any number	
			Y	0.1<Ø<0.2	3	A arra arrando an
		→ +	F	0.2<Ø<0.25	1	Any number
		X		0.25<Ø	0	1
		Line type: as	s per followin		ole quantity	
		∠ W	Length	Width	Zone A	Zone B
		_ */~		W≤0.05	Any number	
		$ \langle \vee - $	L≤2.0	W≤0.1	3	Any number
			L>2.0		0	
		L				
			Total accept	table quantity: 3		
Minor	Polariser	_	rotective film	•		
	scratch		olariser: same	e as No. 1		
Minor	Polariser	$\emptyset = (X+Y)/2$	2			1
	bubble				cceptable quantity	
				Size	Zone A	Zone B
		,	<u>k</u> _	Ø<0.5	Any number	Any number
			Y	Ø>0.5	0	J
		→ _X ← '	r			
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Class	Item	Criteria		
Minor	Segment deformation	1b. Pin hole on dot matrix display	Acceptable Size $a,b<0.1$ $(a+b)/2\leq0.1$ $0.5<\varnothing<1.0$ Total acceptable	Any number Any number 3
		2. Segments / dots with different width	Accep a≥b a <b< td=""><td>table a/b≤4/3 a/b>4/3</td></b<>	table a/b≤4/3 a/b>4/3
		3. Alignment layer defect $\emptyset = (a+b)/2$	Acceptable Size $\emptyset \le 0.4$ $0.4 < \emptyset \le 1.0$ $1.0 < \emptyset \le 1.5$ $1.5 < \emptyset \le 2.0$ Total acceptable	Any number 5 3 2
Minor	Panel Chipping	$X \le 1/6$ Panel length $Y \le 1$ $Z \le T$		7
Minor	Panel Cracking	Cracks not allowed		
Minor	Cupper exposed (pin or film)	Not allowed if visible by eye inspection		
Minor	Film or Trace Damage	Not allowed if affect electrical function		

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Class	Item		Crit	teria	
Minor	Contact Lead Twist	Not allowed		D. TVISTED LEAD	
Minor	Contact Lead Broken	Not allowed		A. BROKEN LEAD	
Minor	Contact Lead Bent	Not allowed if bent lead causes short circuit			
		Not allowed if bent extends horizontall more than 50% of its width	/ !!!!!!!		
Minor	Colour uniformity	Level of sample for approval set as limit sample			
Major	PCB _	No unmelted solder paste should be present on PCB			
Critical		Cold solder joints, missing solder connections, or oxidation are not allowed			
Minor		No residue or solder balls on PCB are allowed			
Critical	T	Short circuits on components are not allowed			
Minor	Tray particles			Size Ø<0.2	Quantity Any number
	particles		On tray	Ø>0.25	4
			On di1	Ø≥0.25	2
			On display	L = 3	1

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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of non-conforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment
High Temperature Operation	70°C±2, 240 hours	No abnormalities in function and appearance
Low Temperature Operation	-30°C±2, 240 hours	No abnormalities in function and appearance
High Temperature Storage	80°C±2, 240 hours	No abnormalities in function and appearance
Low Temperature Storage	-40°C±2, 240 hours	No abnormalities in function and appearance
High Temperature & High Humidity Storage(Operation)	60°C±2, 90%RH, 120 hours	No abnormalities in function and appearance
Thermal Shock	24 cycle of -40°C 1 Hour, 85°C 1 Hour	No abnormalities in function and appearance

- The brightness should be greater than 50% of the initial brightness.
- The samples used for above tests do not include polarizer.
- No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23±5 °C; 55±15% RH

8.2 LIFE TIME

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 10,000 hours under 100 CD/m² brightness and storage conditions of room temperature (25±10 °C), normal humidity (45±20% RH), and in area not exposed to direct sunlight.
2	End of lifetime is specified as 50% of initial brightness.

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9 HANDLING PRECAUTIONS

Safety

If the panel breaks, be careful not to get the organic substance in your mouth or in your eyes. If the organic substance touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during OLED cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to V_{DD} or V_{SS} . Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use OLED elements, and must be treated as such. Avoid strong shock and drop from a height.

To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.

Other Precautions

When a display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

Storage

Store the display in a dark place where the temperature is $25^{\circ}\text{C} \pm 10^{\circ}\text{C}$ and the humidity below 50%RH.

Store the display in a clean environment, free from dust, organic solvents and corrosive gases. Do not crash, shake or jolt the display (including accessories).

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